

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild guestions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



January 2012

FL6961 Single-Stage Flyback and Boundary Mode PFC Controller for Lighting

Features

- Boundary Mode PFC Controller
- Low Input Current THD
- Controlled On-Time PWM
- Zero-Current Detection
- Cycle-by-Cycle Current Limiting
- Leading-Edge Blanking Instead of RC Filtering
- Low Startup Current: 10µA Typical
- Low Operating Current: 4.5mA Typical
- Feedback Open-Loop Protection
- Programmable Maximum On-Time (MOT)
- Output Over-Voltage Clamping Protection
- Clamped Gate Output Voltage: 16.5V

Applications

- General LED Lighting
- Industrial, Commercial and Residential Fixtures
- Outdoor Lighting: Street, Roadway, Parking, Construction, and Ornamental LED Lighting

Description

The FL6961 is a general lighting power controller for low- to high-power lumens applications requiring power factor correction. It is designed for flyback or boost converter operating in Boundary Mode.

The FL6961 provides a controlled on-time to regulate the output DC voltage and achieves natural power factor correction (PFC). The maximum on-time of the external switch is programmable to ensure safe operation during AC brownouts. An innovative multi-vector error amplifier provides rapid transient response and precise output voltage clamping. A built-in circuit disables the controller if the output feedback loop is opened. The startup current is lower than 20µA and the operating current is less than 6mA. The supply voltage can be up to 25V, maximizing application flexibility.

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method	
FL6961MY	-40°C to +125°C	8-Pin, Small Outline Package (SOP)	Tape & Reel	

Application Diagram

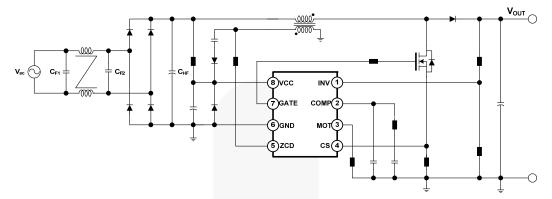


Figure 1. Typical Application Circuit for Step-up Converter

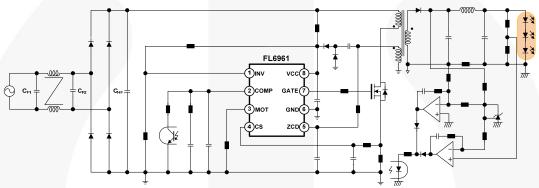


Figure 2. Typical Application Circuit for Single Stage PFC Converter

Block Diagram

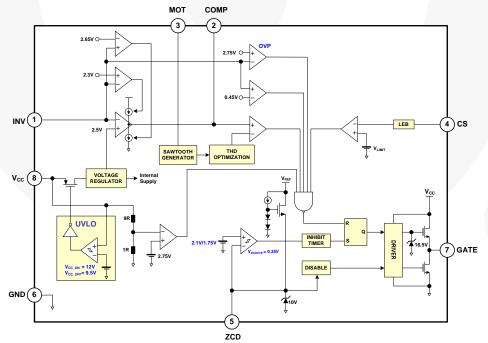
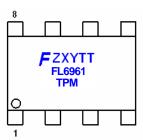


Figure 3. Function Block Diagram

Marking Information



F- Fairchild Logo

Z- Plant Code

X- Year Code

Y- Week Code

TT: Die Run Code

T: Package Type (M=SOP)

P: Z: Pb Free Y: Green Compound

M: Manufacture Flow Code

Figure 4. Marking Information

Pin Configuration

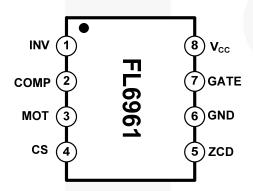


Figure 5. Pin Configuration (Top View)

Pin Definitions

Pin#	Name	Description		
1	INV	nverting Input of the Error Amplifier. INV is connected to the converter output via a resistive livider. This pin is also used for over-voltage clamping and open-loop feedback protection.		
2	COMP	Putput of the Error Amplifier . To create a precise clamping protection, a compensation network etween this pin and GND is suggested.		
3	МОТ	Maximum On Time . A resistor from MOT to GND is used to determine the maximum on-time of the external power MOSFET. The maximum output power of the converter is a function of the maximum on-time.		
4	CS	urrent Sense . Input to the over-current protection comparator. When the sensed voltage across e sense resistor reaches the internal threshold (0.8V), the switch is turned off to activate cycle-y-cycle current limiting.		
5	ZCD	Zero-Current Detection . This pin is connected to an auxiliary winding via a resistor to detect the zero crossing of the switch current. When the zero crossing is detected, a new switching cycle is started. If it is connected to GND, the device is disabled.		
6	GND	Ground . The power ground and signal ground. Placing a 0.1μF decoupling capacitor between V _{CC} and GND is recommended.		
7	GATE	Driver Output . Totem-pole driver output to drive the external power MOSFET. The clamped gate output voltage is 16.5V.		
8	V_{CC}	Power Supply. Driver and control circuit supply voltage.		

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. All voltage values, except differential voltage, are given with respect to GND pin.

Symbol	Parameter	Min.	Max.	Unit
V _{VCC}	DC Supply Voltage		30	V
V_{HIGH}	Gate Driver	-0.3	30.0	V
V_{LOW}	Others (INV, COMP, MOT, CS)	-0.3	7.0	V
V _{ZCD}	Input Voltage to ZCD Pin	-0.3	12.0	V
P _D	Power Dissipation		660	mW
TJ	Operating Junction Temperature	-40	+150	°C
θЈА	Thermal Resistance (Junction-to-Air)		150	°C/W
θ _{JC}	Thermal Resistance (Junction-to-Case)		39	°C/W
T _{STG}	Storage Temperature Range	-65	+150	°C
TL	Lead Temperature (Wave Soldering or IR, 10 Seconds)		+230	°C
ESD	Human Body Model: JESD22-A114		2.5	KV
ESD	Machine Model: JESD22-A115		200	V

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Ī	Symbol	Parameter		Min.	Тур.	Max.	Unit
	T _A	Operating Ambient Temperature		-40		+125	°C

Electrical Characteristics

Unless otherwise noted, V_{CC} =15V and T_J =-40°C to 150°C. Current is defined as positive into the device and negative out of the device.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{CC} Section	on		•	•	•	•
V _{CC-OP}	Continuous Operation Voltage				24.5	V
V _{CC-ON}	Turn-On Threshold Voltage		11.5	12.5	13.5	V
V _{CC-OFF}	Turn-Off Threshold Voltage		8.5	9.5	10.5	V
I _{CC-ST}	Startup Current	V _{CC} =V _{CC-ON} - 0.16V		10	20	μΑ
I _{CC-OP}	Operating Supply Current	V _{CC} =12V, V _{CS} =0V, C _L =3nF, f _{SW} =60KHz		4.5	6	mA
V _{CC-OVP}	V _{DD} Over-Voltage Protection Level		26.8	27.8	28.8	V
t _{D-VCCOVP}	V _{DD} Over-Voltage Protection Debounce			30		μs
Error Am	plifier Section			•		•
V_{REF}	Reference Voltage		2.475	2.500	2.525	V
Gm	Transconductance			125		µmho
V_{INVH}	Clamp High Feedback Voltage			2.65	2.70	V
V_{INVL}	Clamp Low Feedback Voltage		2.25	2.30		V
V _{OUT HIGH}	Output High Voltage		4.8	\		V
V _{OZ}	Zero Duty Cycle Output Voltage		1.15	1.25	1.35	V
$V_{INV\text{-}OVP}$	Over-Voltage Protection for INV Input		2.70	2.75	2.80	V
$V_{INV\text{-}UVP}$	Under-Voltage Protection for INV Input		0.40	0.45	0.50	V
		V _{INV} =2.35V, V _{COMP} =1.5V	10	20		
I _{COMP}	Source Current	V _{INV} =1.5V	550	800		μA
	Sink Current V _{INV} =2.65V, V _{COMP} =5V		10	20		
Current-S	Sense Section	- 1	7	1		
V_{PK}	Threshold Voltage for Peak Current Limit Cycle-by-Cycle Limit		0.77	0.82	0.87	V
t _{PD}	Propagation Delay				200	ns
		R_{MOT} =24k Ω , V_{COMP} =5V		400	500	
t_{LEB}	Leading-Edge Blanking Time	R_{MOT} =24k Ω , V_{COMP} = V_{OZ} +50m V		270	350	ns
Gate Sect	tion		20			\prec
V _Z -out	Output Voltage Maximum (Clamp)	V _{CC} =25V	14.5	16.0	17.5	V
V _{OL}	Output Voltage Low	V _{CC} =15V, I _O =100mA			1.4	V
V_{OH}	Output Voltage High	V _{CC} =14V, I _O =100mA	8			V
t _R	Rising Time	V _{CC} =12V, C _L =3nF, 20~80%		80		ns
t _F	Falling Time	V _{CC} =12V, C _L =3nF, 80~20%		40		ns

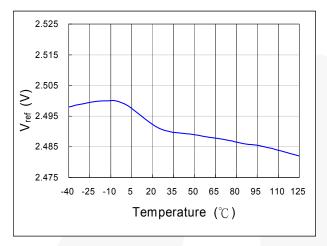
Continued on the following page...

Electrical Characteristics

Unless otherwise noted, V_{CC} =15V and T_J =-40°C to 150°C. Current is defined as positive into the device and negative out of the device.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Zero-Curi	rent Detection Section				•	
V _{ZCD}	Input Threshold Voltage Rising Edge	V _{ZCD} Increasing	1.9	2.1	2.3	V
H_{YS} of V_{ZCD}	Threshold Voltage Hysteresis	V _{ZCD} Decreasing		0.35		V
V _{ZCD-HIGH}	Upper Clamp Voltage	I _{ZCD} =3mA			12	V
V _{ZCD-LOW}	Lower Clamp Voltage	I _{ZCD} =-1.5mA	0.3			V
t _{DEAD}	Maximum Delay, ZCD to Output Turn-On	V _{COMP} =5V, f _{SW} =60KHz	100		400	ns
t _{RESTART}	Restart Time	Output Turned Off by ZCD	300	500	700	μs
t _{INHIB}	Inhibit Time (Maximum Switching Frequency Limit)	R _{MOT} =24kΩ		2.8		μs
V _{DIS}	Disable Threshold Voltage		130	200	250	mV
t _{ZCD-DIS}	Disable Function Debounce Time	R_{MOT} =24k Ω , V_{ZCD} =100m V	800			μs
Maximum	On Time Section					
V_{MOT}	Maximum On Time Voltage		1.25	1.30	1.35	V
t _{ON-MAX}	Maximum On Time Programming (Resistor Based)	R_{MOT} =24k Ω , V_{CS} =0V, V_{COMP} =5V		25		μs

Typical Performance Characteristics



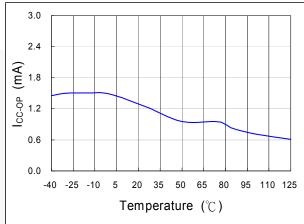


Figure 6. V_{REF} vs. T_A

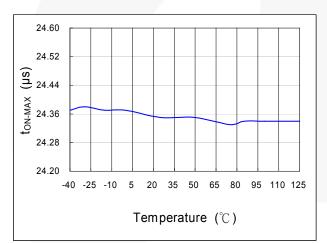


Figure 7. I_{CC-OP} vs. T_A

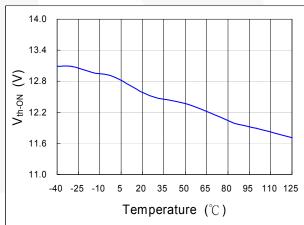


Figure 8. ton-MAX vs. TA

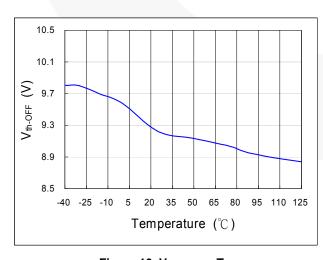


Figure 9. V_{th-ON} vs. T_A

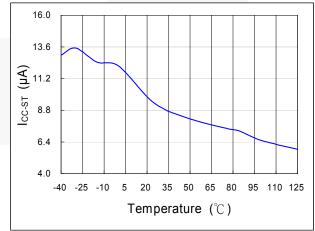
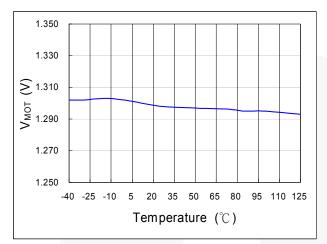


Figure 10. $V_{\text{th-OFF}}$ vs. T_{A}

Figure 11. $I_{\text{CC-ST}}$ vs. T_{A}

Typical Performance Characteristics (Continued)



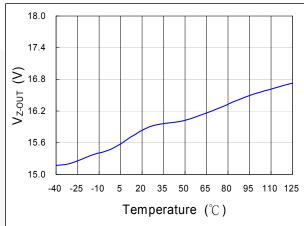


Figure 12. V_{MOT} vs. T_A

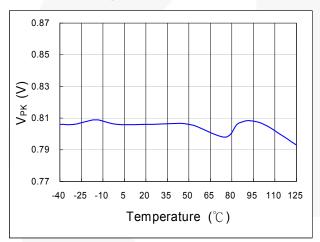


Figure 14. V_{PK} vs. T_A

Figure 13. V_{Z-OUT} vs. T_A

Functional Description

Error Amplifier

The inverting input of the error amplifier is referenced to INV. The output of the error amplifier is referenced to COMP. The non-inverting input is internally connected to a fixed 2.5V ±2% voltage. The output of the error amplifier is used to determine the on-time of the PWM output and regulate the output voltage. To achieve a low input current THD, the variation of the on-time within one input AC cycle should be very small. A multivector error amplifier is built in to provide fast transient response and precise output voltage clamping.

Connecting a capacitance, such as $1\mu F$, between COMP and GND is suggested. The error amplifier is a trans-conductance amplifier that converts voltage to current with a $125\mu mho$.

Startup Current

Typical startup current is less than $20\mu A$. This ultra-low startup current allows the usage of a high resistance, low-wattage startup resistor. For example, $1M\Omega/0.25W$ startup resistor and a $10\mu F/25V$ (V_{CC} hold-up) capacitor are recommended for an AC-to-DC power adaptor with a wide input range $85-265V_{AC}$.

Operating Current

Operating current is typically 4.5mA. The low operating current enables better efficiency and reduces the requirement of V_{CC} hold-up capacitance.

Maximum On-Time Operation

Given a fixed inductor value and maximum output power, the relationship between on-time and line voltage is:

$$t_{on} = \frac{2 \cdot L \cdot P_o}{V_{rms}^2 \cdot \eta} \tag{1}$$

If the line voltage is too low or the inductor value is too high, t_{ON} is too long. To avoid extra low operating frequency and achieve brownout protection, the maximum value of t_{ON} is programmable by one resistor, R_{I} , connected between MOT and GND. A 24k Ω resistor R_{I} generates corresponds to 25 μ s maximum on time:

$$t_{on(\max)} = R_I(k\Omega) \cdot \frac{25}{24} (\mu s)$$
 (2)

The range of the maximum on-time is $10 \sim 50 \mu s$.

Peak Current Limiting

The switch current is sensed by one resistor. The signal is fed into the CS pin and an input terminal of a comparator. A high voltage on the CS pin terminates the switching cycle immediately and cycle-by-cycle current limit is achieved. The designed threshold of the protection point is 0.82V.

Leading-Edge Blanking (LEB)

A turn-on spike on the CS pin appears when the power MOSFET is switched on. At the beginning of each switching pulse, the current-limit comparator is disabled for around 400ns to avoid premature termination. The gate drive output cannot be switched off during the blanking period. Conventional RC filtering is not necessary, so the propagation delay of current limit protection can be minimized.

Under-Voltage Lockout (UVLO)

The turn-on and turn-off threshold voltages are fixed internally at 12V and 9.5V, respectively. This hysteresis behavior guarantees a one-shot startup with proper startup resistor and hold-up capacitor. With an ultra-low startup current of $20\mu A$, one $1M\Omega$ R_{IN} is sufficient for startup under low input line voltage, $85V_{rms}$. Power dissipation on R_{IN} would be less than 0.1W even under high line $(V_{AC} \! = \! 265V_{rms})$ condition.

Output Driver

With low on resistance and high current driving capability, the output driver can drive an external capacitive load larger than 3000pF. Cross conduction current has been avoided to minimize heat dissipation, improving efficiency and reliability. This output driver is internally clamped by a 16.5V Zener diode.

Zero-Current Detection (ZCD)

The zero-current detection of the inductor is achieved using its auxiliary winding. When the stored energy of the inductor is fully released to output, the voltage on ZCD goes down and a new switching cycle is enabled after a ZCD trigger. The power MOSFET is always turned on with zero inductor current such that turn-on loss and noise can be minimized. The converter works in Boundary Mode and peak inductor current is always exactly twice of the average current. A natural power factor correction function is achieved with the low-bandwidth, on-time modulation. An inherent maximum off time is built in to ensure proper startup operation. This ZCD pin can be used as a synchronous input.

Noise Immunity

Noise on the current sense or control signal can cause significant pulse-width jitter, particularly in Boundary Mode. Slope compensation and a built-in debounce circuit can alleviate this problem. Because the FL6961 has a single ground pin, high sink current at the output cannot be returned separately. Good high-frequency or RF layout practices should be followed. Avoiding long PCB traces and component leads, locating compensation and filter components near to the FL6961, and increasing the power MOSFET gate resistance all improve performance.

Physical Dimensions

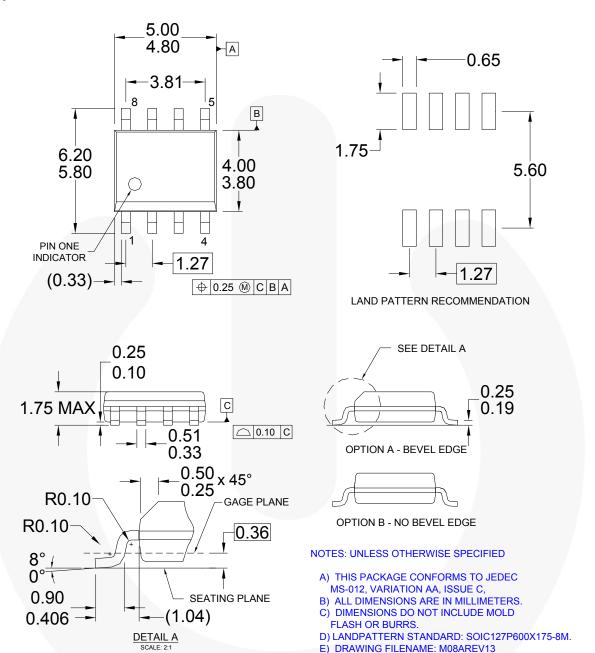


Figure 15. 8-Lead, SOIC, JEDEC MS-012, .150 Inch Narrow Body

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

F-PFS™ 2Cool™ AccuPower™ FRFET® Global Power ResourceSM AX-CAP™* GreenBridge™ BitSiC^{TI} Green FPS™ Build it Now™ Green FPS™ e-Series™ CorePLUS™ Gmax™ CorePOWER™ GTO™ CROSSVOLT™ IntelliMAX™ **CTL™**

Current Transfer Logic™ ISOPLANAR™

DEUXPEED® Making Small Speakers Sound Louder

Dual Cool™ and Better™

EcoSPARK® MegaBuck™

MISOPCOURLERING

MISOPCOURLERING

EcoSPARK®

EfficientMax™

ESBC™

MicroFET™

MicroPak™

Faircniid Semiconductor

FACT Quiet Series™

FACT®

FAST®

FastvCore™

FastvCore™

FiashWriter®

FlashWriter®

FlashWriter®

FastvCore™

FlashWriter®

Flas

PowerTrench® PowerXS™

Programmable Active Droop™

QFET[®] QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

Solutions for Your
SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-8
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™
GENERAL®*

The Power Franchise®

TinyBoost™
TinyCalc™
TinyCalc™
TinyCogic®
TinyOPTO™
TinyPower™
TinyPWM™
TinyWire™
TranSiC™
TriFault Detect™
TRUECURRENT®

µSerDes™

Serices*
UHC®
UHtra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS, THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a)
 are intended for surgical implant into the body or (b) support or
 sustain life, and (c) whose failure to perform when properly used in
 accordance with instructions for use provided in the labeling, can be
 reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Delimition of Terms		
Datasheet Identification	atasheet Identification Product Status Definition	
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I61

^{*} Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Power Factor Correction - PFC category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

L6564TD FAN7930MX L4984D NCP1612A1DR2G NCP1618ADR2G TDA4863GXUMA2 ICE2PCS06GXUMA1 PFS7624C-TL

TDA48632GXUMA2 UCC29910APWR DCRG8 UCC2818AQDRQ1 TDA4862GGEGXUMA2 L6561D013TR L6566B ICE3PCS03G

AL1788W6-7 LT1249CN8#PBF NCP1616A1DR2G LT1509CN#PBF BR6000-R12 ICE3PCS02GXUMA1 DCRL5 B44066R6012E230

ICE2PCS01GXUMA1 ADP1048ARQZ-R7 LT1249IS8#PBF LT1249CS8#PBF FAN6920MRMY FAN4801SMY AL6562AS-13

ICE1PCS01G NCP1652DR2G ICE2PCS05GXUMA1 ICE2PCS01G ICE2PCS06G ICE3PCS01G ICE3PCS01GXUMA1 TDA4863

TDA4863-2 TDA4863-2G XDPL8210XUMA1 AP1682EMTR-G1 ISL6731BFBZ NCP1615A1DR2G NCP1605DR2G LT1509CSW#PBF

IRS2505LTRPBF TEA1761T/N2/DG,118 TEA1762T/N2/DG,118